



N 沟道增强型场效应晶体管  
N-Channel MOSFET  
FHP230N06V

主要参数 MAIN CHARACTERISTICS

ID( $T_c=25^\circ\text{C}$ , Silicon Limited)	230A
VDSS	60 V
Rdson-typ (@ $V_{gs}=10\text{V}$ )	2.5 mΩ
Qg-typ	160 nC

用途 APPLICATIONS

逆变器	Inverter
同步整流	Synchronous rectification
DC-DC	DC-DC
不间断电源	UPS (Uninterruptible Power Supplies)

产品特性 FEATURES

低内阻	Low On-Resistance
低栅极电荷	Low gate charge
低 Crss (典型值 629pF)	Low Crss (typical 629pF )
开关速度快	Fast switching
100% 经过雪崩测试	100% avalanche tested
100% 经过热阻测试	100% DVDS tested
100% 经过 Rg 测试	100% Rg tested
符合 RoHS 标准	RoHS compliant
飞虹特色沟槽工艺技术	FH-Trench technology

封装形式 Package

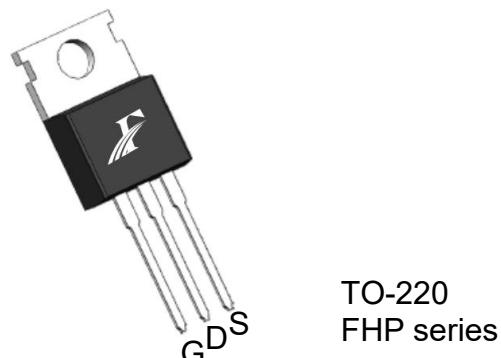
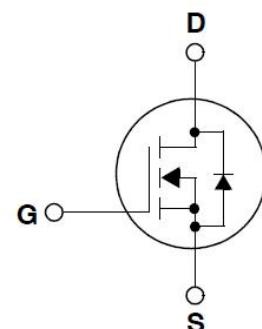


示意图 Schematic diagram



绝对最大额定值 ABSOLUTE RATINGS ( $T_c=25^\circ\text{C}$ )

项目 Parameter	符号 Symbol	数值 Value	单位 Unit
		FHP230N06V	
最高漏极—源极直流电压 Drain-Source Voltage	V <sub>DS</sub>	60	V
连续漏极电流* Drain Current -continuous *	I <sub>D</sub> ( $T_c=25^\circ\text{C}$ ), Silicon Limited	230	A
	I <sub>D</sub> ( $T_c=25^\circ\text{C}$ ), Package Limited	163	A
	I <sub>D</sub> ( $T_c=100^\circ\text{C}$ ), Silicon Limited	163	A
最大脉冲漏极电流 (注 1) Drain Current – pulse (note 1)	I <sub>DM</sub>	640	A
最高栅源电压 Gate-Source Voltage	V <sub>GS</sub>	±20	V
单脉冲雪崩能量 (注 2) Single Pulsed Avalanche Energy (note 2)	E <sub>AS</sub>	1740	mJ
单脉冲雪崩能量测试值 (注 3) Single Pulsed Avalanche Energy Tested Value (note 3)	E <sub>AS</sub> (Tested)	435	mJ
耗散功率 Power Dissipation	P <sub>D</sub> ( $T_c=25^\circ\text{C}$ )	313	W
	-Derate above 25°C	2.08	W/°C
最高结温及存储温度 Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	175, -55~+175	°C
引线最高焊接温度 Maximum Lead Temperature for Soldering Purposes (1.6mm from case for 10s)	T <sub>L</sub>	260	°C

\*漏极电流由最高结温限制

\*Drain current limited by maximum junction temperature

## 电特性 ELECTRICAL CHARACTERISTICS

项目 Parameter	符号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units	
<b>关态特性 Off -Characteristics</b>							
漏—源击穿电压 Drain-Source Voltage	$BV_{DSS}$	$I_D=250\mu A, V_{GS}=0V$	60	70	-	V	
击穿电压温度特性 Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta TJ$	$I_D=250\mu A$ , referenced to $25^\circ C$	-	0.056	-	V/ $^\circ C$	
零栅压下漏极漏电流 Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=60V, V_{GS}=0V, TJ=25^\circ C$	-	0.1	1	$\mu A$	
		$V_{DS}=60V, TJ=125^\circ C$	-	-	250	$\mu A$	
栅极体漏电流 Gate-body leakage current	$I_{GSS} (F/R)$	$V_{DS}=0V, V_{GS} =\pm 20V$	-	-	$\pm 100$	nA	
<b>通态特性 On-Characteristics</b>							
阈值电压 Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D=250\mu A$	2	-	4	V	
静态导通电阻 Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS} =10V$ , $I_D=80A$	-	2.5	3.0	$m\Omega$	
<b>动态特性 Dynamic Characteristics</b>							
栅电阻 Gate Resistance	$R_g$	$f=1.0MHz, V_{DS} OPEN$	-	0.9	-	$\Omega$	
输入电容 Input capacitance	$C_{iss}$	$V_{DS}=25V$ , $V_{GS} =0V$ , $f=1.0MHz$	-	8656	-	pF	
输出电容 Output capacitance	$C_{oss}$		-	830	-		
反向传输电容 Reverse transfer capacitance	$C_{rss}$		-	629	-		
<b>开关特性 Switching Characteristics</b>							
延迟时间 Turn-On delay time	$t_{d(on)}$	$V_{DS}=30V$ , $I_D=80A$ , $R_G=10\Omega$ $V_{GS} =10V$ (note 4)	-	52	-	ns	
上升时间 Turn-On rise time	$t_r$		-	157	-	ns	
延迟时间 Turn-Off delay time	$t_{d(off)}$		-	137	-	ns	
下降时间 Turn-Off Fall time	$t_f$		-	136	-	ns	
栅极电荷总量 Total Gate Charge	$Q_g$	$V_{DS} =30V$ , $I_D=80A$ , $V_{GS} =10V$ (note 4)	-	160	-	nC	
栅—源电荷 Gate-Source charge	$Q_{gs}$		-	42	-	nC	
栅—漏电荷 Gate-Drain charge	$Q_{gd}$		-	58	-	nC	
<b>漏—源二极管特性及最大额定值 Drain-Source Diode Characteristics and Maximum Ratings</b>							
正向最大连续电流 Maximum Continuous Drain -Source Diode Forward Current	$I_S$		-	-	163	A	
正向最大脉冲电流 (注 1) Maximum Pulsed Drain-Source Diode Forward Current (note1)	$I_{SM}$		-	-	640	A	
正向压降 Drain-Source Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=80A$	-	0.87	1.2	V	
反向恢复时间 Reverse recovery time	$t_{rr}$	$V_{GS}=0V, I_S=80A$ , $dI_F/dt=100A/\mu s$ (note 4)	-	42	-	ns	
反向恢复电荷 Reverse recovery charge	$Q_{rr}$		-	40	-	nC	

## 热特性 THERMAL CHARACTERISTIC

项目 Parameter	符号 Symbol	Max	单位 Unit
结到管壳的热阻 Thermal Resistance, Junction to Case	R <sub>th(j-c)</sub>	0.48	°C/W
结到环境的热阻 Thermal Resistance, Junction to Ambient	R <sub>th(j-A)</sub>	62.5	°C/W

注释:

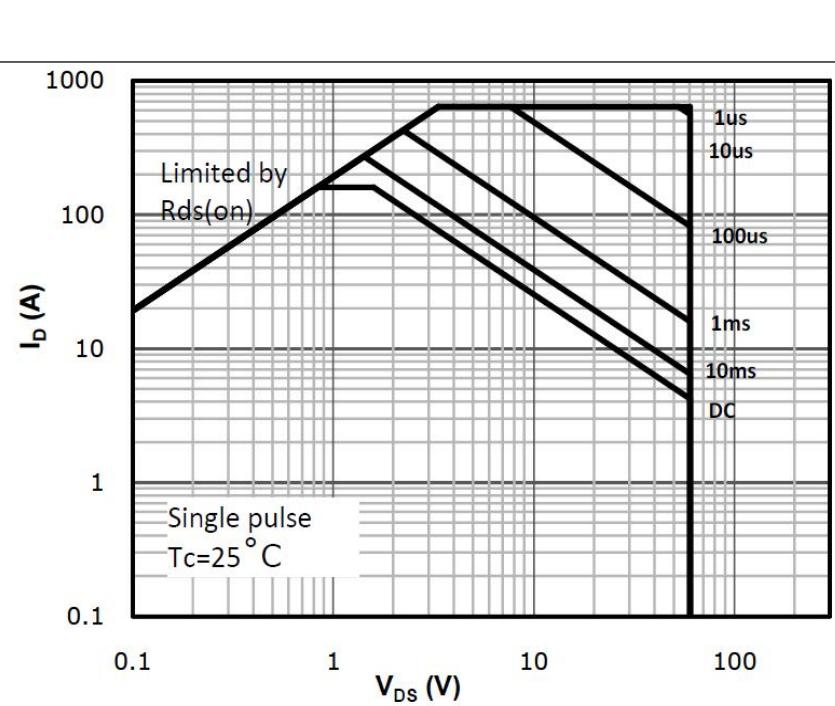
- 1: 脉冲宽度由最高结温限制
- 2: L=1mH, V<sub>DD</sub>=50V, R<sub>G</sub>=25 Ω,起始结温 T<sub>J</sub>=25°C
- 3: 该值由故障样本确定，在生产中 100% 测试了该值。
- 4: 脉冲测试: 脉冲宽度 ≤300μs, 占空比≤2%

Notes:

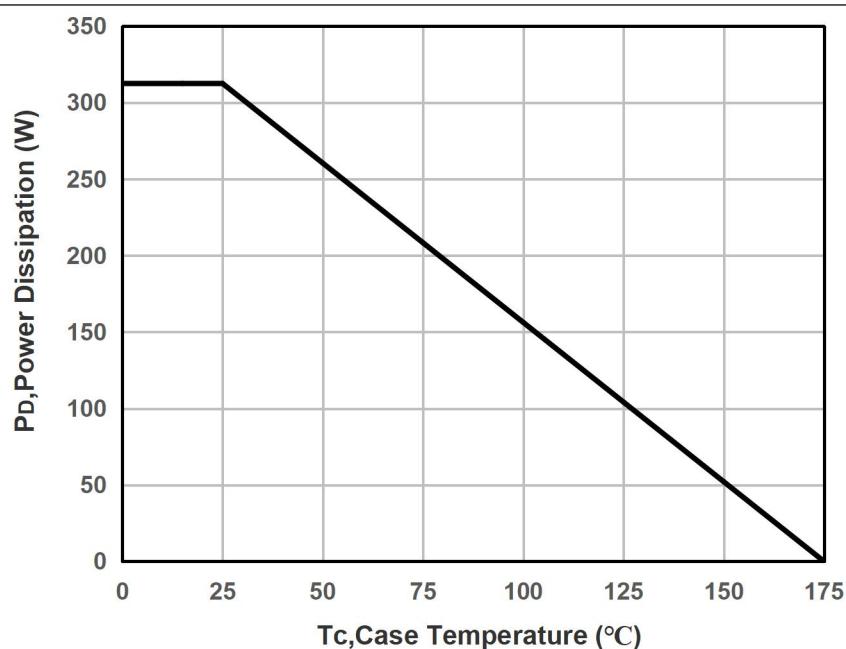
- 1: Pulse width limited by maximum junction temperature
- 2: L=1mH, V<sub>DD</sub>=50V, R<sub>G</sub>=25 Ω, Starting T<sub>J</sub>=25°C
- 3: This value determined from sample failure population, 100% tested to this value in production.
- 4: Pulse Test: Pulse Width ≤300μs,Duty Cycle≤2%

## 典型特性曲线 Typical Performance Characteristics

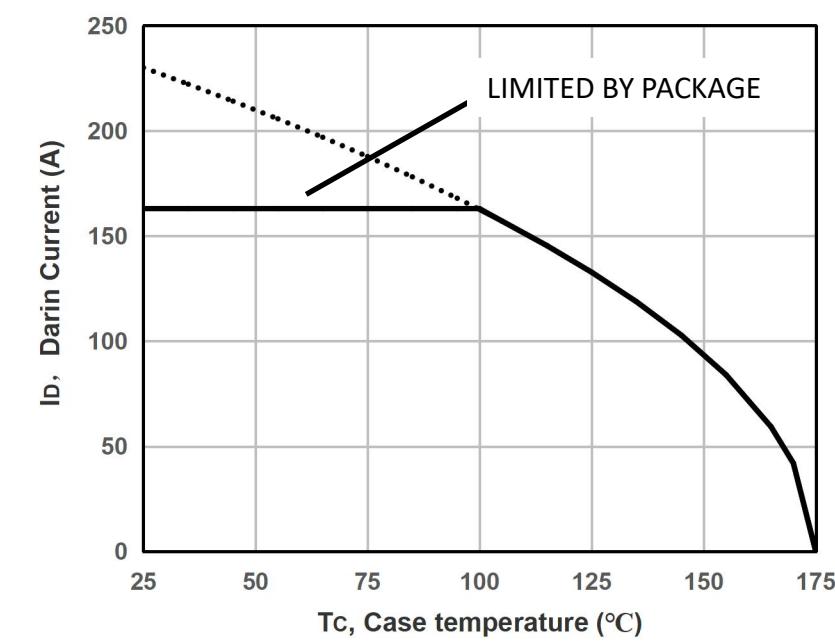
**Figure 1. Safe Operating Area**



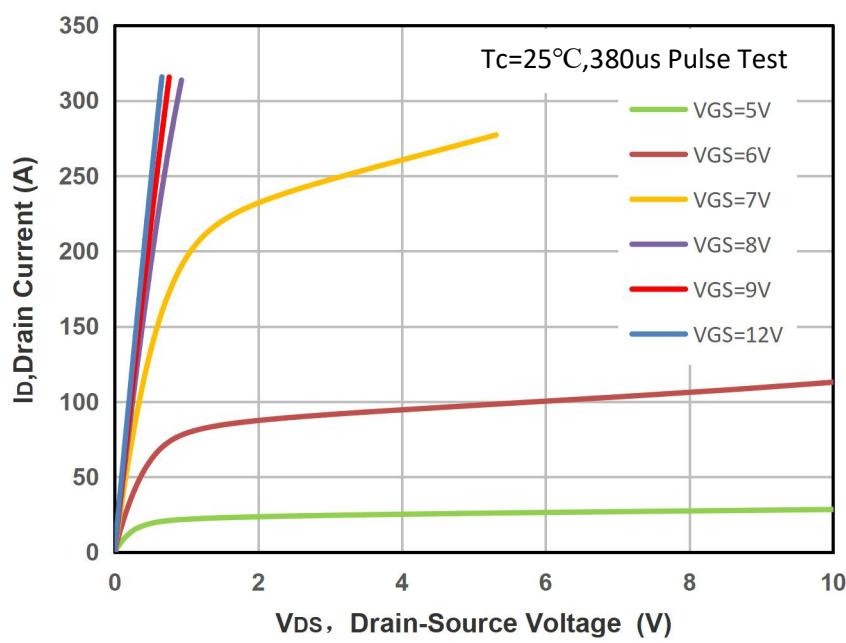
**Figure 2. Maximum power Dissipation vs Case Temperature**



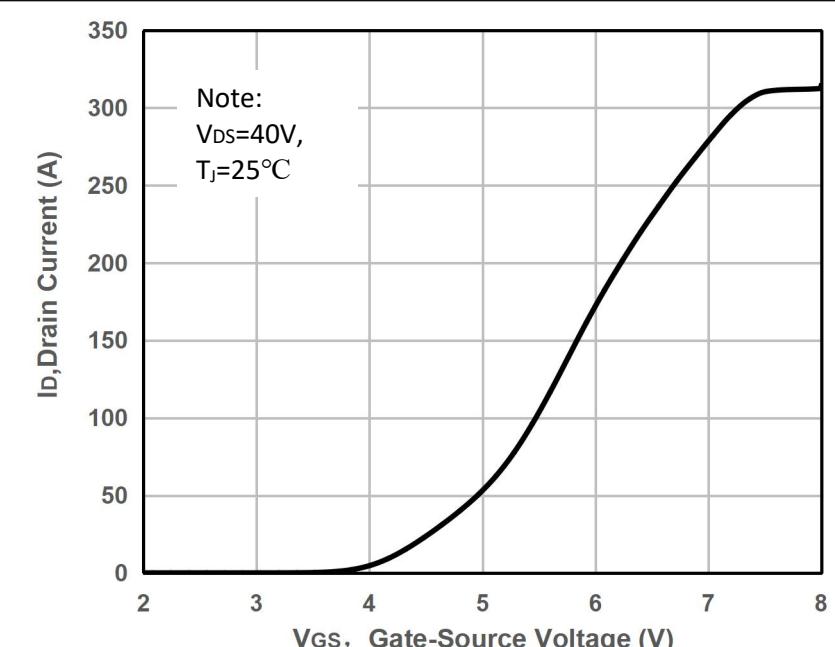
**Figure 3. Maximum Continuous Drain Current vs Case Temperature**



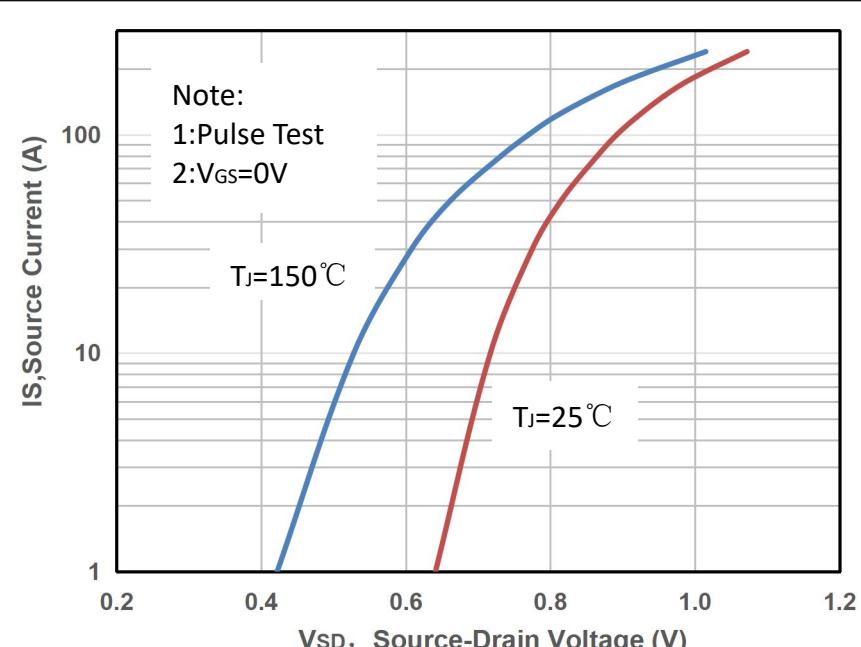
**Figure 4. Typical Output Characteristics**



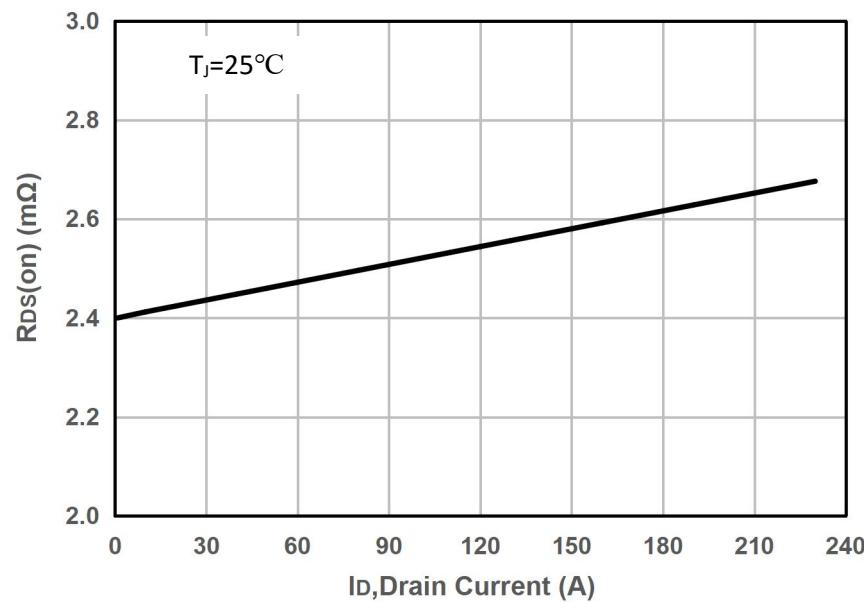
**Figure 5. Typical Transfer Characteristics**



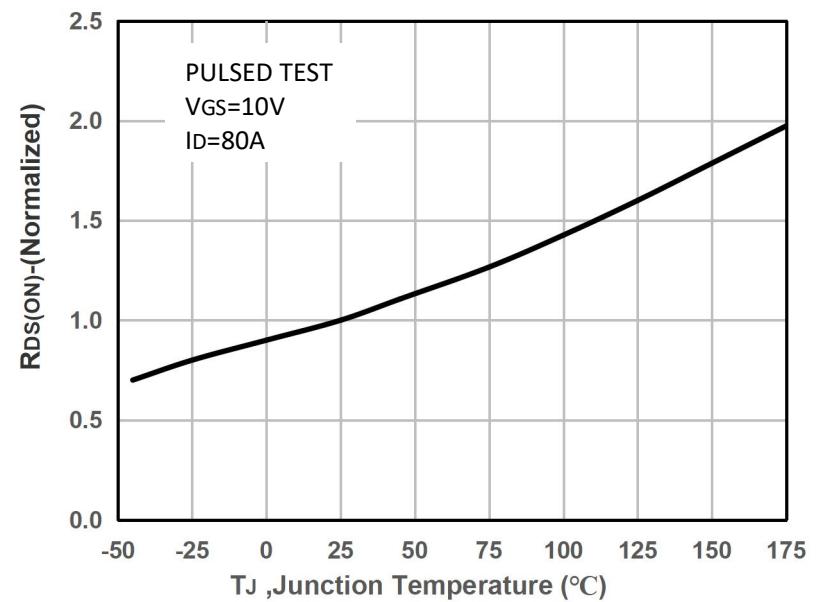
**Figure 6. Source-Drain Diode Forward Characteristics**



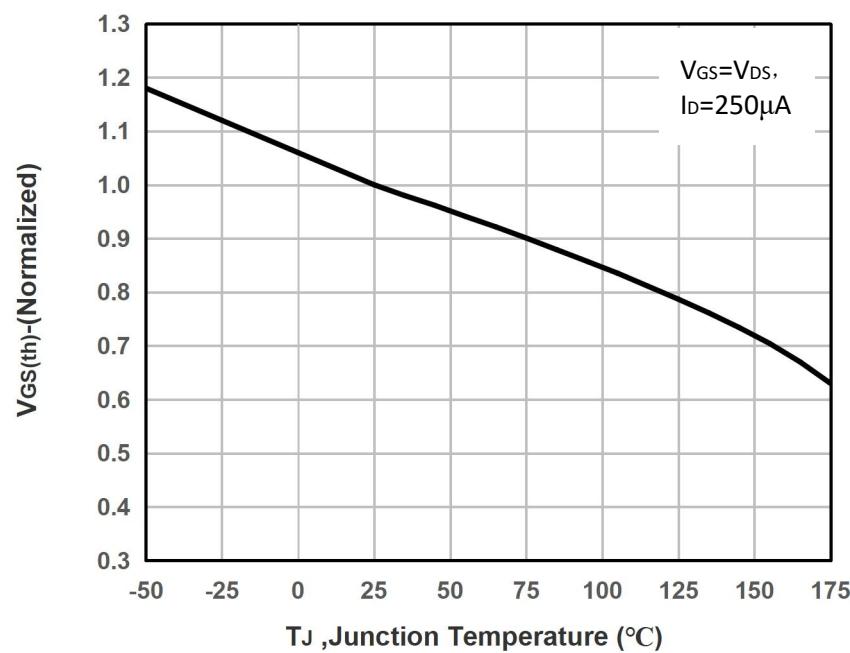
**Figure 7. Drain-Source On-Resistance vs Drain Current**



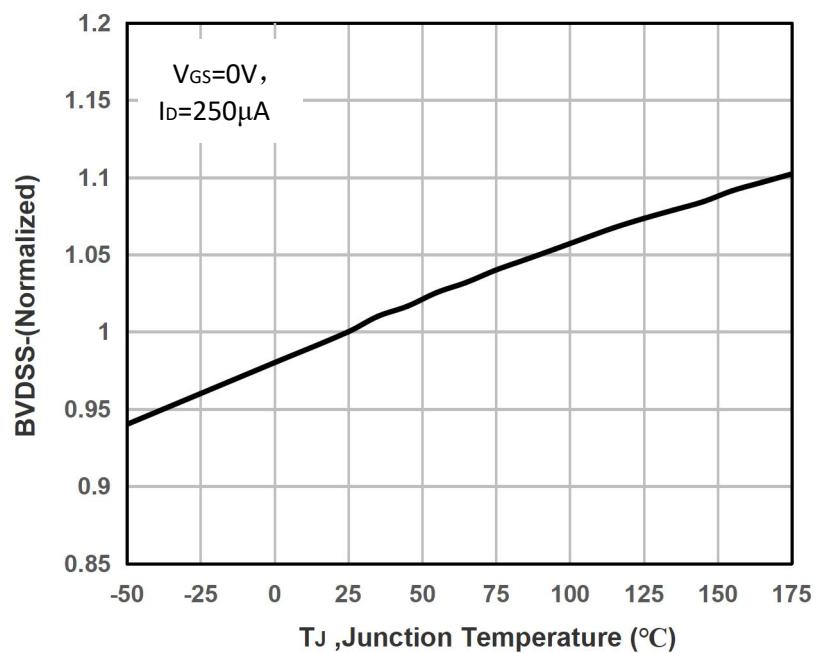
**Figure 8. Normalized On-Resistance vs Junction Temperature**



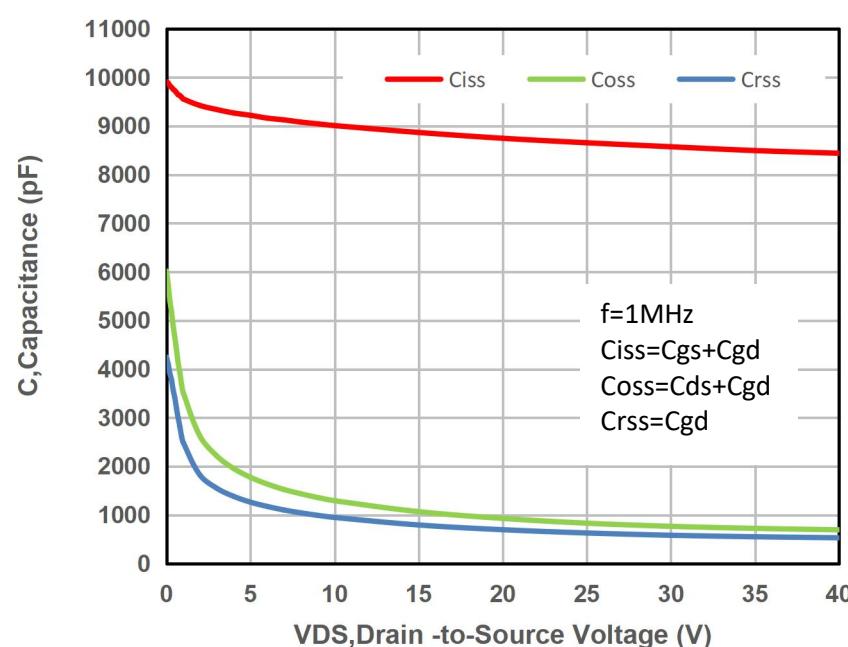
**Figure 9. Normalized Threshold Voltage vs Junction Temperature**



**Figure 10. Normalized Breakdown Voltage vs Junction Temperature**



**Figure 11. Capacitance Characteristics**



**Figure 12. Typical Gate Charge vs Gate-Source Voltage**

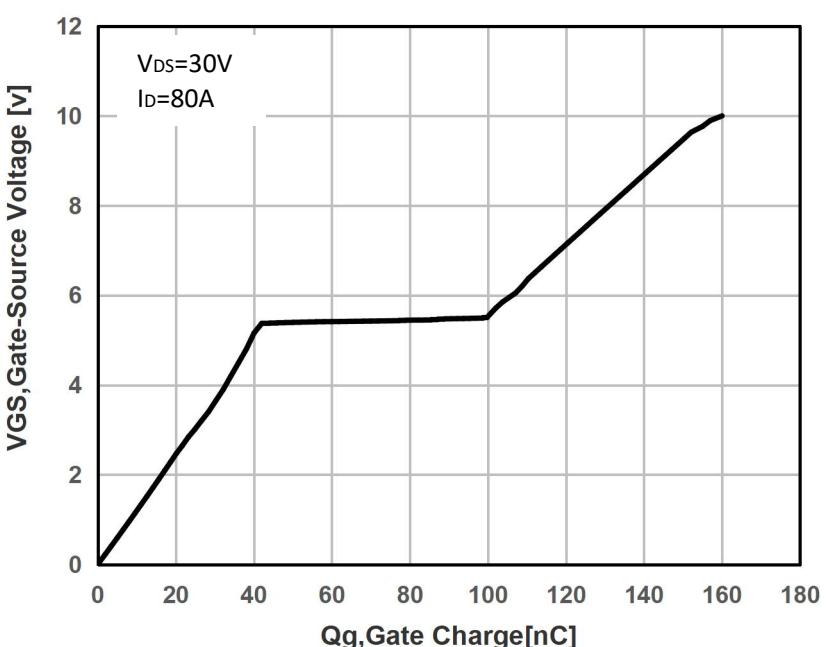
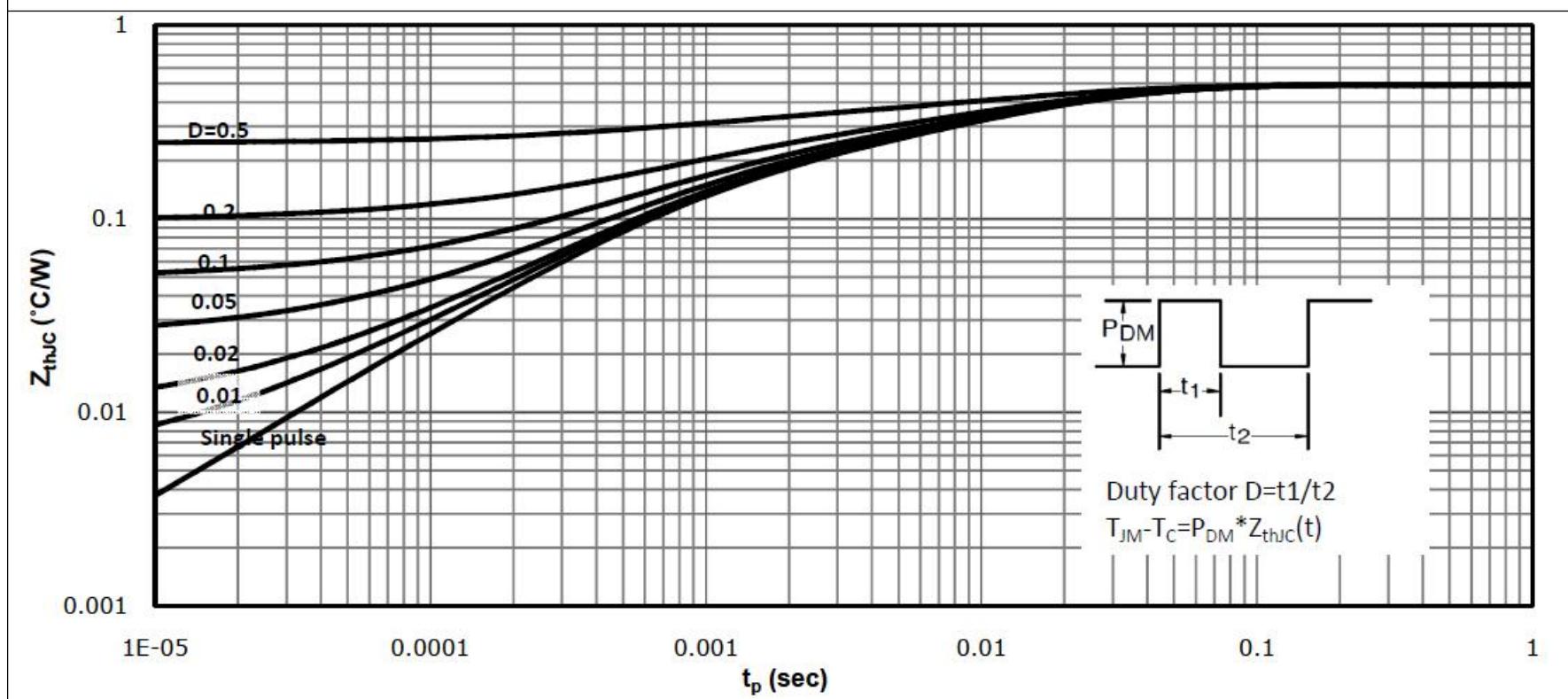
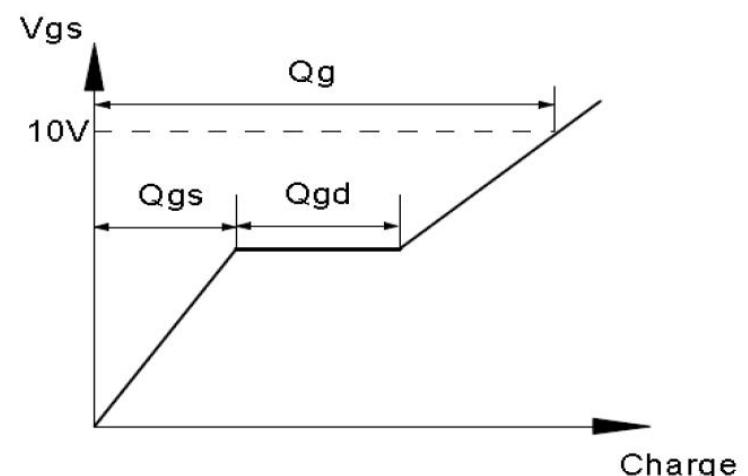
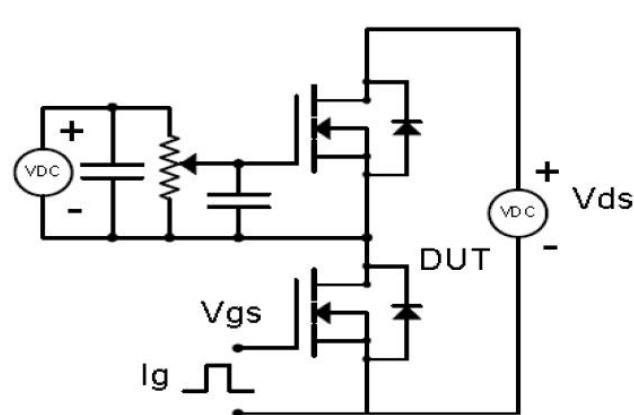


Figure 13. Transient Thermal Impedance

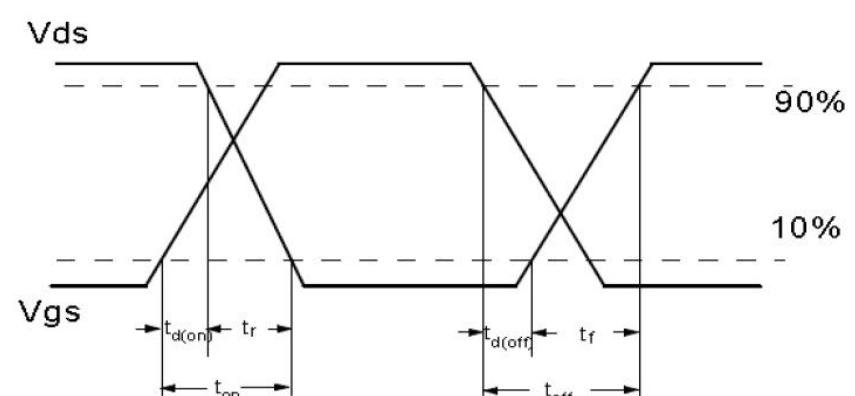
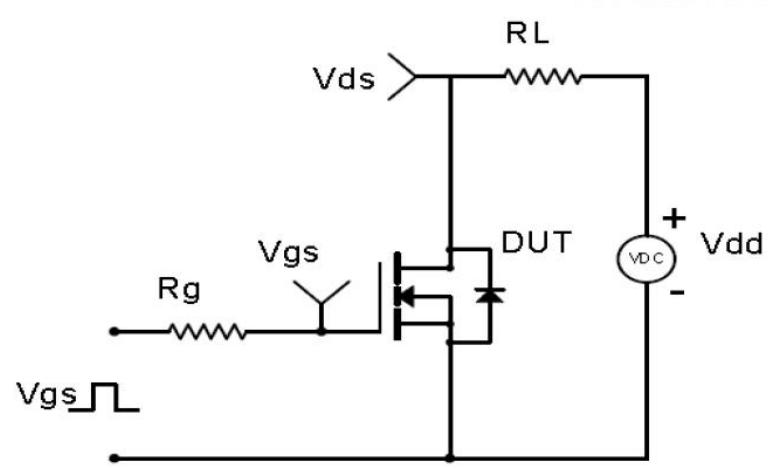


## Test Circuit & Waveform

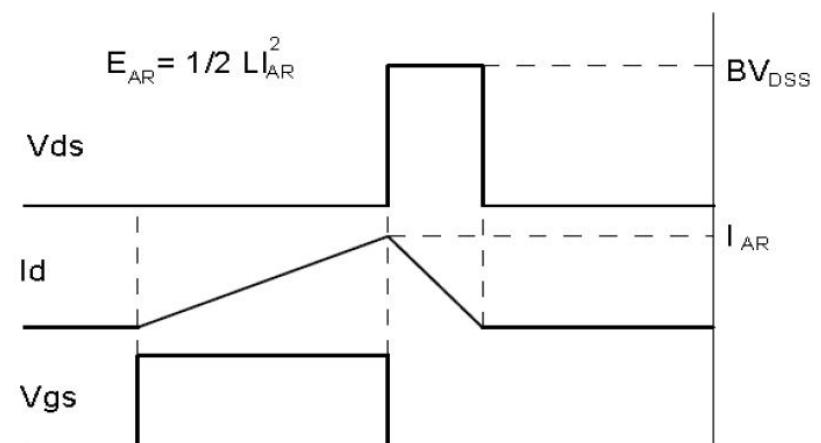
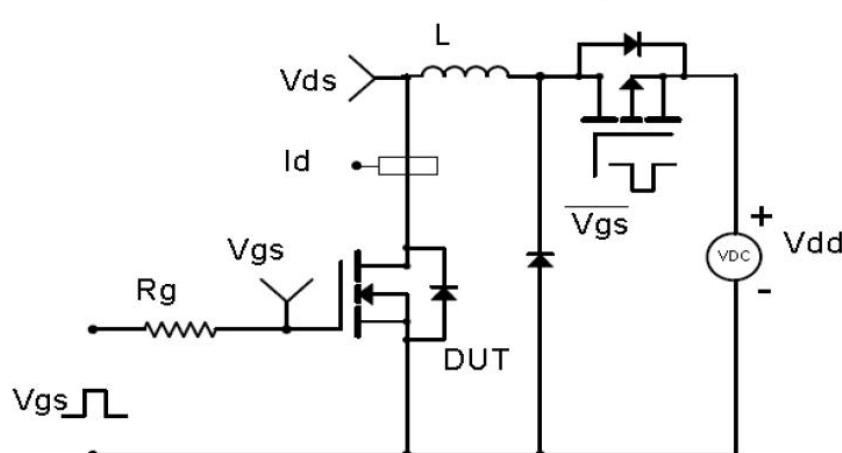
Gate Charge Test Circuit & Waveform



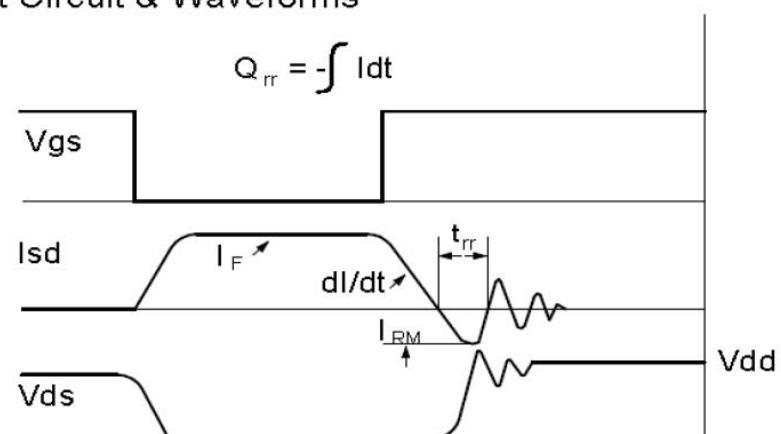
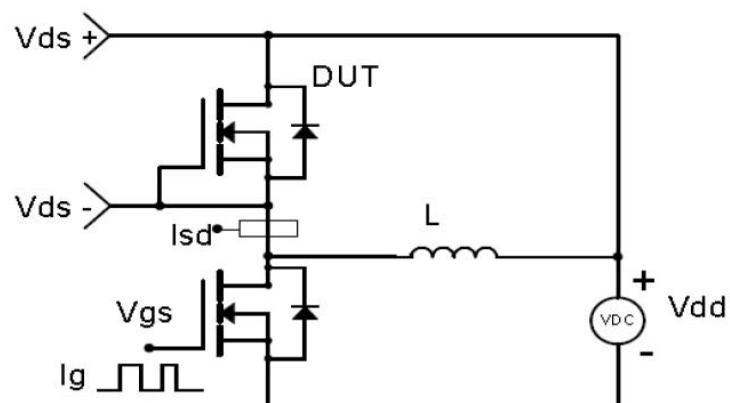
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

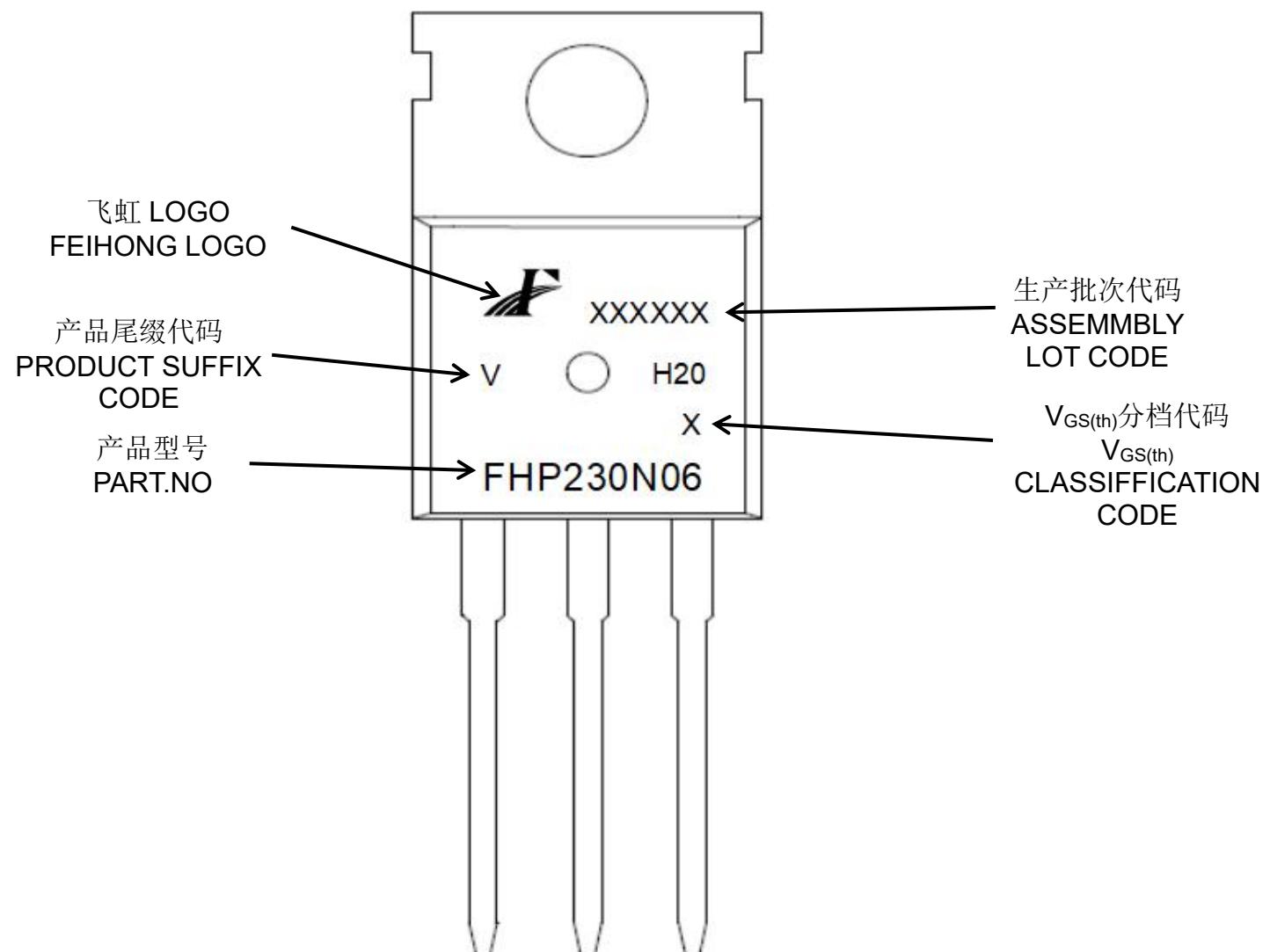


Diode Recovery Test Circuit & Waveforms



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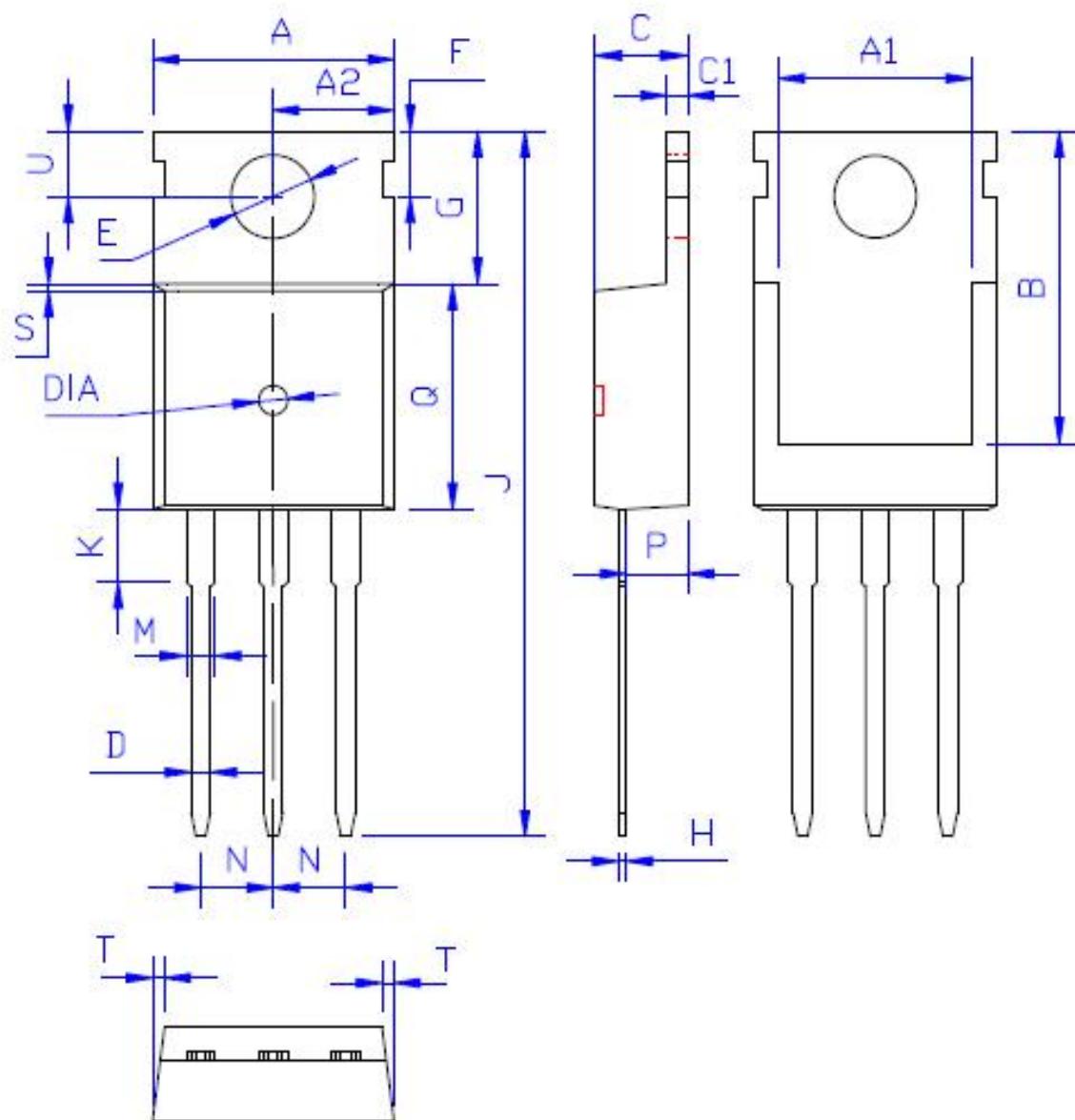
**印记 Marking:**



外形尺寸:

Package Dimension:

TO-220



DIM	MILLIMETERS
A	10.00±0.30
A1	8.00±0.30
A2	5.00±0.30
B	13.20±0.40
C	4.50±0.20
C1	1.30±0.20
D	0.80±0.20
E	3.60±0.20
F	3.00±0.30
G	6.60±0.40
H	0.50±0.20
J	28.88±0.50
K	3.00±0.30
M	1.30±0.30
N	Typical 2.54
P	2.40±0.40
Q	9.20±0.40
S	0.25±0.15
T	0.25±0.15
U	2.80±0.30
DIA	宽 1.50±0.10 深 0.50 MAX

(Unit: mm)